**Phi Beta Sigma Fraternity, Inc.**

**Kappa mu sigma Alumni Chapter
ΦΒΣ
*Our Motto: “Culture for Service,
Service for Humanity”***

March 2023

 Dear High School Senior, School Official, Church Administrator, Community Member:

The men of Kappa Mu Sigma Alumni Chapter of Phi Beta Sigma Fraternity, Incorporated are pleased to offer scholarships(s) for the 2022 - 2023 school year. We award the scholarship(s) on or about June 10, 2023.

Phi Beta Sigma Fraternity, Inc was founded on the campus of Howard University in Washington D.C. on January 9, 1914. Phi Beta Sigma Fraternity, Inc. with chapters throughout the United States, the Caribbean, Europe and Asia, continues to provide service to humanity as expressed in our principles of “Brotherhood”, “Scholarship”, and “Service”.

We are seeking African American High School Seniors who plan to attend a post-secondary accredited college/university. The scholarship application can be downloaded from the chapter website [www.pbs1914kms.org](http://www.pbs1914kms.org). Once on the website, click on “Programs”, then “Scholarship”. A link to the scholarship form will be available for downloading.

**Applications can be submitted electronically (preferred) or by mail. All applications must be submitted or postmarked by April 24, 2023. Electronic submissions must be sent to Phi Beta Sigma Fraternity, Inc.** **kmspbs1914@gmail.com**

If you have any questions contact Melvin Wright at 309-838-5413 (c), or contact James Joyner at 309-531-4288 (c).

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**Application for Scholarship**

**2023**

**Criteria:**

1. You must be an African American graduating high school senior who will be enrolled full-time at an accredited Post-Secondary Institution for the 2022 – 2023 school year.

2. You must reside in the Bloomington/Normal area.

**Instructions:**

1. The application must be typewritten or legibly handwritten.
2. An official high school transcript must accompany the application.
3. Based upon the history of Phi Beta Sigma Fraternity, Inc., what inspired you to apply for the fraternity scholarship. Please attach your thoughts in a 300-word essay.
4. Attach a 300-word essay by answering **one** of the following questions:
* Who has been your role model and why?
* What is the importance of community service and what does it mean to you?
* What in life is important to you?
1. Please include at least two letters of reference. The respondents can submit their letter electronically to the email address in #6 below.
2. If submitting electronically, send your submission(s) to: kmspbs1914@gmail.com
3. If submitting by paper, send the application and all other related material to:

Phi Beta Sigma Fraternity, Inc.

Kappa Mu Sigma Alumni Chapter

Scholarship and Educational Development Committee

P. O. Box 632

Bloomington, IL 61702

 6. All submissions are due by **April 24, 2023.**

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**2023**

**Application for Scholarship**

**Section I**

Last Name First Name Middle Initial

Street Address

City State Zip Home Phone

Parent(s) or Guardian’s Last Name First Name Middle Initial

Are your parents(s), guardian(s) or any relative(s) members of Phi Beta Sigma Fraternity, Inc or Zeta Phi Beta Sorority, Inc. \_\_\_\_Yes\_\_\_\_ No. If yes, please provide their name(s):**\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_**

**Section II**

High School Name

Street Address

City State Zip Office Phone

Graduation Date SAT/ACT Score GPA/Scale

Accredited post-secondary institution you plan to attend:

Have you been accepted? Yes No

What curriculum do you plan to study?

**Section III (Please do not use acronyms)**

**List your school activities/Honors and Awards (List offices held).**

**List your Employment/Community/Church Activities/Hobbies and any Volunteered Activities.**

**Signature Date**